

# **Bias Resistor Transistors** (BRT)

PNP, 50 V, 100 mA

# **NSBAMXW** Series

The series of digital transistors is designed to replace a single device and its external resistor bias network. The Bias Resistor Transistor contains a single transistor with a monolithic bias network consisting of two resistors: a series base resistor and a base-emitter resistor. The BRT eliminates these individual components by integrating them into a single device. The use of a BRT can reduce both system cost and board space. They are housed in the DFN1010-3 package offering superior thermal performance. The transistor is ideal for surface mount applications where board space and reliability are at a premium.

#### **Features**

- Built in Bias Resistors
- Complimentary NPN Types Available
- XDFNW3 Package Offers Low Seated Height 0.44 mm Max
- Wettable Flank Package for Optimal Automated Optical Inspection (AOI)
- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

## **Applications**

- Digital Switching
- Controlling IC Input

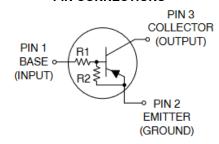
## MAXIMUM RATINGS (T<sub>A</sub> = 25°C)

Rating	Symbol	Min	Max	Unit
Collector - Emitter Voltage	$V_{CEO}$		-50	٧
Collector - Base Voltage	$V_{CBO}$		-50	٧
Input Voltage NSBA114EMXWTBG NSBA124EMXWTBG NSBA143EMXWTBG NSBA144EMXWTBG NSBA123YMXWTBG	VI	-40 -40 -30 -40 -5	+10 +10 +10 +10 +12	<b>V</b>
Collector Current	I <sub>C</sub>		100	mA
Electrostatic Discharge (HBM)	ESD		Class 1B	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



## **PIN CONNECTIONS**



## **MARKING DIAGRAM**



XX = Specific Device Code M = Date Code

## **ORDERING INFORMATION**

See detailed ordering, marking and shipping information on page 2 of this data sheet.

## THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Power Dissipation @ T <sub>A</sub> = 25°C (Note 1)	$P_{D}$	450	mW
Thermal Resistance, Junction-to-Ambient (Note 1)	$R_{\theta JA}$	145	°C/W
Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +150	°C

<sup>1.</sup> Per JESD51-7 with standard PCB footprint and 2 oz. Cu.

# **ORDERING INFORMATION**

Device	Device-Automotive*	R1	R2	Part Marking	Package <sup>†</sup>	Shipping	
NSBA114EMXWTBG	NSVBA114EMXWTBG	10	10	4X	XDFNW3	3000 / Tape & Reel	
NSBA124EMXWTBG	NSVBA124EMXWTBG	22	22	4Y	(Pb-Free)		
NSBA143EMXWTBG	NSVBA143EMXWTBG	4.7	4.7	4V			
NSBA144EMXWTBG	NSVBA144EMXWTBG	47	47	4Z			
NSBA123YMXWTBG	NSVBA123YMXWTBG	2.2	10	4W			

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

\*S and NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and

PPAP Capable.

# **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted)

	Characteristic	Symbol	Min	Тур	Max	Unit
Collector-Base Cutoff Current (V <sub>CB</sub> = -50 V, I <sub>E</sub> = 0)		I <sub>CBO</sub>	_	_	-100	nA
Collector-Emitter Cutoff Curren	t (V <sub>CE</sub> = -50 V, I <sub>B</sub> = 0)	I <sub>CEO</sub>	-	-	-500	nA
Emitter-Base Cutoff Current $(V_{EB} = -5 \text{ V}, I_C = 0)$	NSBA114E	I <sub>EBO</sub>	-	-	-0.5	mA
	NSBA124E		-	-	-0.2	
	NSBA143E		-	-	-1.5	
	NSBA144E		-	-	-0.13	1
	NSBA123Y		-	-	-0.7	1
DC Current Gain	NSBA114E	h <sub>FE</sub>	35	-	-	
$(V_{CE} = -10.0 \text{ V}, I_{C} = -5 \text{ mA})$	NSBA124E		60	-	-	
	NSBA143E		15	-	-	1
	NSBA144E		80	-	-	
	NSBA123Y		35	-	-	1
Collector-Emitter Saturation Vo	Itage ( $I_C = -10 \text{ mA}, I_B = -0.3 \text{ mA}$ )	V <sub>CE(sat)</sub>	-	-	-0.25	V
Input Voltage (off)	NSBA114E	V <sub>I(off)</sub>	-	-1.2	-0.8	V
$(V_{CE} = -5.0 \text{ V}, I_{C} = -100 \mu\text{A})$	NSBA124E		-	-1.2	-0.8	
	NSBA143E		-	-1.2	-0.5	
	NSBA144E		-	-1.2	-0.8	
	NSBA123Y		-	-0.75	-0.3	
Input Voltage (on)	NSBA114E ( $V_{CE} = -0.3 \text{ V, } I_{C} = -10 \text{ mA}$ )	V <sub>I(on)</sub>	-2.5	-1.8	-	V
	NSBA124E ( $V_{CE} = -0.3 \text{ V, } I_{C} = -5 \text{ mA}$ )		-2.5	-1.7	-	
	NSBA143E ( $V_{CE} = -0.3 \text{ V, } I_{C} = -20 \text{ mA}$ )		-3	-2.4	-	
	NSBA144E ( $V_{CE} = -0.3 \text{ V}, I_{C} = -5 \text{ mA}$ )		-3	-1.6	-	
	NSBA123Y ( $V_{CE} = -0.3 \text{ V, } I_{C} = -20 \text{ mA}$ )		-2.5	-1.15	-	
Output Voltage (on) (V <sub>CC</sub> = 5.0	$V, V_B = 3.5 V, R_L = 1.0 kΩ$	V <sub>OL</sub>	-	-	0.2	V
Output Voltage (off) (V <sub>CC</sub> = 5.0	$V, V_B = 0.5 V, R_L = 1.0 k\Omega$	V <sub>OH</sub>	4.9	-	-	V
Bias Resistor (R1)	NSBA114E	R1	7	10	13	kΩ
	NSBA124E		15.4	22	28.6	
	NSBA143E		3.3	4.7	6.1	
	NSBA144E		32.9	47	61.1	
	NSBA123Y		1.54	2.2	2.86	1
Resistor Ratio	NSBA114E	R1/R2	0.8	1	1.2	
	NSBA124E		0.8	1	1.2	1
	NSBA143E		0.8	1	1.2	1
	NSBA144E		0.8	1	1.2	1
	NSBA123Y		0.18	0.22	0.27	1

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

## **TYPICAL CHARACTERISTICS (Ref NSBA124E)**

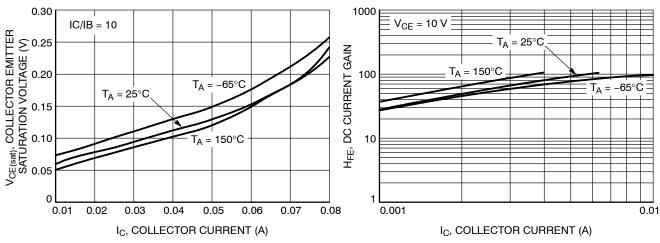


Figure 1. V<sub>CE(sat)</sub> vs. I<sub>C</sub>

Figure 2. DC Current Gain

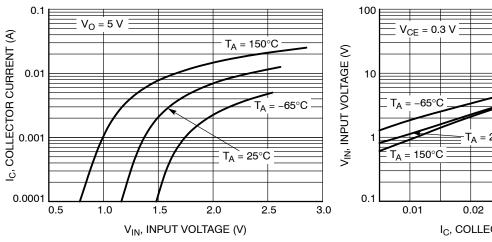


Figure 3. Output Current vs. Input Voltage

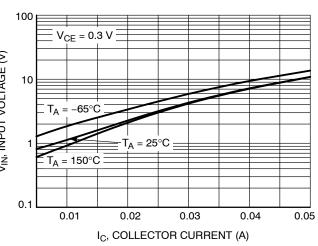


Figure 4. Input Voltage vs. Output Current

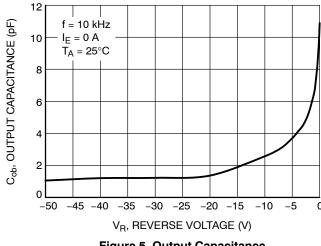


Figure 5. Output Capacitance

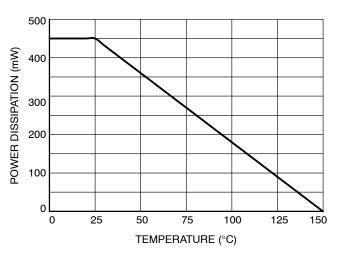


Figure 6. Derating Curve

## **TYPICAL CHARACTERISTICS**

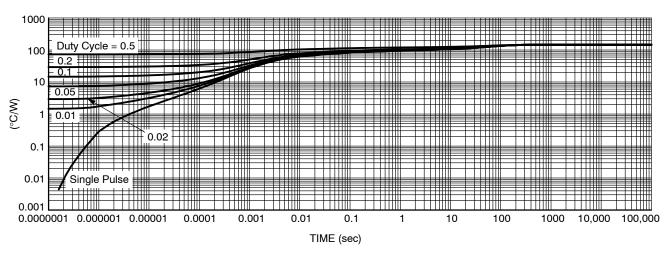


Figure 7. Transient Thermal Impedance from Junction-to-Ambient as a Function of Pulse Duration



PIN 1 REFERENCE

## XDFNW3 1.00x1.00x0.38 0.65P CASE 521AC **ISSUE B**

**DATE 07 MAY 2024** 

#### NOTES:

**PLATED** 

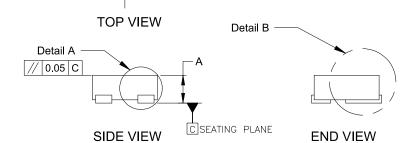
**SURFACE** 

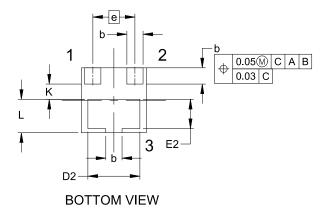
- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018.
- 2. CONTROLLING DIMENSION: MILLIMETERS

	MILLIMETERS			
DIM	MIN.	NOM.	MAX.	
Α	0.32	0.38	0.44	
A1	0.00		0.04	
А3	0.125 REF			
b	0.20	0.25	0.30	
D	0.90	1.00	1.10	
D1	0.00		0.04	
D2	0.75	0.80	0.85	
Е	0.90	1.00	1.10	
E2	0.40	0.45	0.50	
е	0.65 BSC			
L	0.465	0.515	0.565	
K	0.23 REF			

D1

**PLATED** 

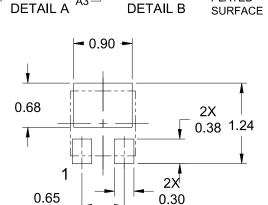




## **GENERIC MARKING DIAGRAM\***



XX = Specific Device Code = Month Code NΛ



A3

**PITCH** 

# RECOMMENDED **MOUNTING FOOTPRINT\***

For additional information on our Pb-Free strategy and soldering details, please download the ONSEMI Soldering and Mounting Techniques Reference Manual, S●LDERRM/D.

DESCRIPTION:	XDFNW3 1.00x1.00x0.38 0.65P PAGE		PAGE 1 OF 1
DOCUMENT NUMBER:	98AON11341H  Electronic versions are uncontrolled except when accessed directly from the Documer Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red		

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